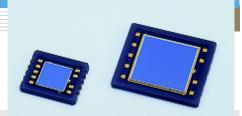
Two-dimensional PSD **\$5990-01**, **\$5991-01**



Improved tetra-lateral type for surface mounting

Features

- Large active area S5990-01: 4 × 4 mm S5991-01: 9 × 9 mm
- Chip carrier package for surface mounting (automatic mounting with solder reflow) thin package: 1.26 mmt
- Improved tetra-lateral type (pin-cushion type) delivers superior position detection
- Evaluation circuit boards provided C4674 (DC signal processing circuit) C7563 (AC signal processing circuit)

Applications

- Spot light detection
- Pointing device (computer mouse, track-ball)
- Position measurement

■ Absolute maximum ratings (Ta=25 °C)

Absolute maximum ra	ungs (ra-za) C)	
Parameter	Symbol	Value	Unit
Reverse voltage	VR Max.	20	V
Operating temperature	Topr	-20 to +60	°C
Storage temperature	Tstg	-20 to +80	°C

■ Electrical and optical characteristics (Ta=25 °C)

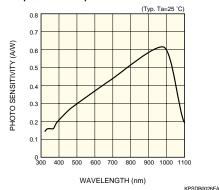
Parameter	Symbol	Condition	S5990-01			S5991-01			Unit
			Min.	Тур.	Max.	Min.	Тур.	Max.	Offic
Spectral response range	λ		-	320 to 1100	ı	ı	320 to 1100	ı	nm
Peak sensitivity wavelength	λр		-	960	1	•	960	1	nm
Photo sensitivity	S	λ=λρ	-	0.6	1	•	0.6	1	A/W
Interelectrode resistance	Rie	Vb=0.1 V	5	7	15	5	7	15	kΩ
Position detection error	E	λ=900 nm VR=5 V, spot light size: φ0.2 mm *	-	±70	±150	1	±150	±250	μm
Saturation photocurrent	Ist	λ =900 nm, VR=5 V RL=1 k Ω	-	500	ı	1	500	1	μΑ
Dark current	ΙD	VR=5 V	-	0.5	10	•	1	50	nA
Rise time	tr	VR=5 V, RL=1 kΩ λ =900 nm	-	1	-		2		μs
Terminal capacitance	Ct	VR=5 V, f=10 kHz	-	150	300		500	1000	pF
Position resolution	ΔR	lo=1 μA, B=1 kHz *	-	0.7	-	-	1.5	-	μm

^{*} In the range that is 80 % from the center to the edge. Recommended spot light size is larger than φ0.2 mm.

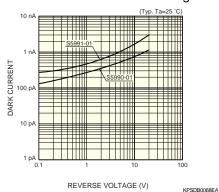


Two-dimensional PSD S5990-01, S5991-01

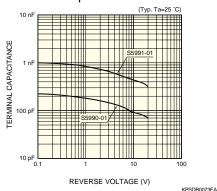
■ Spectral response



■ Dark current vs. reverse voltage



■ Terminal capacitance vs. reverse voltage



S5991-01

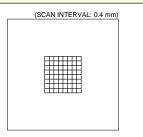
ACTIVE AREA

X2

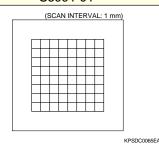
 14.5 ± 0.2

■ Example of position detectability (Ta=25 °C, λ=830 nm, Spot light size: ϕ 0.2 mm)

S5990-01

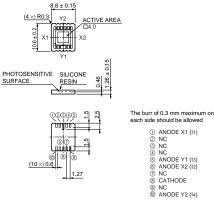


S5991-01



■ Dimensional outlines (unit: mm)

S5990-01



(3) pin should be open-circuited

SURFACE

(4 x) R0.3

① ANODE X1 (I1) 3 NC 4 NC 5 ANC (a) NC (b) ANODE Y1 (I3) (b) ANODE X2 (I2) (7) NC (a) CATHODE (a) NC (b) ANODE Y2 (I4)

(3) pin should be open-circuited

The burr of 0.3 mm maximum on each side should be allowed

■ Conversion formula

$$\frac{(|2+|3) - (|1+|4)}{|1+|2+|3+|4|} = \frac{2x}{L}$$

 $\frac{(12+14)-(11+13)}{1}=\frac{2y}{1}$ 11 + 12 + 13 + 14

x, y: position coordinate of spot light

S5990-01: L=4.5 mm S5991-01: L=10 mm Precautions for use

- The light input window of this product uses soft silicone resin. Avoid touching the window to keep it from grime and damage that can decrease sensitivity. External force applied to the resin surface may deform or cut off the wires, so do not touch the window to prevent such troubles.
- Use rosin flux when soldering, to prevent the terminal lead corrosion. Reflow oven temperature should be at 260 °C maximum for 5 seconds maximum time under the conditions that no moisture absorption occurs.
- Reflow soldering conditions differ depending on the type of PC board and reflow oven. Carefully check these conditions before use.
- Silicone resin swells when it absorbs organic solvent, so do not use any solvent other than alcohol.
- Avoid unpacking until you actually use this product to prevent the terminals from oxidation and dust deposits or the coated resin from absorbing moisture.

When the product is stored for 3 months while not unpacked or 24 hours have elapsed after unpacking, perform baking in nitrogen atmosphere at 150 °C for 3 to 5 hours or at 120 °C for 12 to 15 hours before use.

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